

## OCTOPLUS 500 / MBE SYSTEM

- 2", 3", 4" or 6" substrate size
- N<sub>2</sub> Iq cooling shroud
- <5x10<sup>-11</sup> mbar base pressure
- 11 source flanges
- 3 additional sources on request
- III-V, II-VI or other materials
- RHEED, BFM, Quartz, Pyrometer etc.
- Soft-acting Rotary or Linear Shutters



Octoplus 500 MBE System



System control rack

The Octoplus 500 series is a state-of-the-art MBE system with up to 14 effusion cell flanges. High quality epitaxial layers on substrates up to 6" in diameter can be deposited.

The Octoplus 500 provides convenient source access and excellent service-ability due to its open design. It is ideally suited and field proven for cutting edge research on a large variety of materials including GaAs, phosphides, antimonides, nitrides and topological insulator deposition.

The MBE process control software integrates easy recipe writing, automated growth control and extensive data recording.

All our MBE products are designed and manufactured by Dr. Eberl MBE-Komponenten GmbH. The products are cleaned and assembled in our own clean room environment. Each component is tested and outgassed under UHV conditions. Helium leak testing and operation at maximum conditions are performed to reach the high standard of our products.

Dr. Eberl MBE-Komponenten GmbH is specialized on customized products. Due to our 25 year experience in MBE technology we are able to offer individually designed system solutions which follow our customers' needs.

The MBE systems are installed and acceptance tested by experienced MBE PhD experts. Extensive customer training is offered as an additional option.



## Technical Data

Size of deposition chamber	550 mm ID			
Base pressure	< 5x10 <sup>-11</sup> mbar			
Pumping	TSP, Ion getter, Cryo and/or Turbo pump			
Cooling shroud	N <sub>2</sub> lq or other cooling liquid on request			
Substrate heater temperature	up to 800°C, 1000°C or 1400°C			
Substrate size	up to 6" diameter or 7x2" wafer			
Bakeout temperature	up to 200°C			
Sources flanges	11 flanges (+3 on request), DN 63 and DN 100 CF			
Source types	Effusion Cells, E-Beam-Evaporators, Sublimation			
	Sources, Valved Cracker Sources, Gas Sources			
Shutters	Soft-acting Linear or Rotary Shutters			
In-situ monitoring	lon-gauge, quartz, pyrometer, RHEED, QMA			
Sample transfer	linear transfer rod, manual or semi-automatic			
	in face-down geometry			
Load-lock	Magazin with 6 or more substrates turbo-pumped			
MBE control software	Epi-soft or other			
System installation and acceptance testing	included			
MBE training	by MBE expert			

## Examples for applications and corresponding sources

Application	Effusion	Sublimation	Valved	Plasma	E-Beam
	Cell	Source	Source	Source	Evaporator
Source type	WEZ/NTEZ	SUKO, SUSI	VACS, VGCS		EBVV
	OME/HTEZ	HTS, DECO	VCS, VSCS		
III/V (As, Sb, P)	Ga, In, Al, Be	C, Si doping	As, P, Sb		
II/VI	Zn, Cd, Be		S, Se, Te	N-doping	
IV	Ge, Sn, Pb	B, P, Sb doping			Si, Ge
GaN	Ga, In, Al			N	
Metals / Magnetics	Cu,Al,Ni,Co,				Pt, Ta, Pd,
Topological Insulators	Ge, Sb, Te,		Se, Te		В
	Bi, GeSb				
Graphene		C, Si			
Oxides	Fe, Ni, Mn, Bi,			0	
	Eu, Ga,				
Thin Film Solar Cell	Cu, Ga, In, Zn,		S, Se		
	NaF, Fe, Sn				

## MBE Components typically used in the Octoplus 500









Substrate Manipulator

Effusion Cell

Linear Shutter

Valved Cracker Source

www.mbe-components.com

Dr. Eberl MBE-Komponenten GmbH

Josef-Beyerle-Str. 18/1

71263 Weil der Stadt, Germany
Fon +49 7033 6937-0
Fax +49 7033 6937-290
Mail info@mbe-components.com
Web www.mbe-components.com